

## CM400DY-24A

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Apr.	M. Tabata 28-Feb-'03			M. Tabata 9-May-'03

HIGH POWER SWITCHING USE

CM400DY-24A

- $I_c$  ..... 400A
- $V_{CES}$  ..... 1200V
- Insulated Type
- 2-elements in a pack

## APPLICATION

AC drive inverters &amp; Servo controls, etc

ABSOLUTE MAXIMUM RATINGS ( $T_j = 25\text{ }^\circ\text{C}$ )

Symbol	Item	Conditions	Ratings	Units
$V_{CES}$	Collector-emitter voltage	G-E Short	1200	V
$V_{GES}$	Gate-emitter voltage	C-E Short	$\pm 20$	V
$I_c$	Collector current	DC, $T_c = 87\text{ }^\circ\text{C}^*1$	400	A
$I_{CM}$		Pulse (2)	800	
$I_E$ (1)	Emitter current		400	A
$I_{EM}$ (1)		Pulse (2)	800	
$P_C$ (3)	Maximum collector dissipation	$T_c = 25\text{ }^\circ\text{C}^*1$	2710	W
$T_j$	Junction temperature		$-40 \sim +150$	$^\circ\text{C}$
$T_{stg}$	Storage temperature		$-40 \sim +125$	$^\circ\text{C}$
Viso	Isolation voltage	Main terminal to base plate, AC 1 min.	2500	V
—	Torque strength	Main terminal M6	3.5 ~ 4.5	N·m
—	Torque strength	Mounting holes M6	3.5 ~ 4.5	N·m
—	Weight	Typical value	580	g

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HIGH POWER SWITCHING USE

ELECTRICAL CHARACTERISTICS ( $T_j = 25\text{ }^\circ\text{C}$ )

Symbol	Item	Conditions	Min.	Typ.	Max.	Units
$I_{CES}$	Collector cutoff current	$V_{CE}=V_{CES}, V_{GE}=0V$	—	—	1	mA
$V_{GE(th)}$	Gate-emitter threshold voltage	$I_C=40mA, V_{CE}=10V$	6	6.8	7.5	V
$I_{GES}$	Gate leakage current	$V_{GE}=V_{GES}, V_{CE}=0V$	—	—	0.5	$\mu A$
$V_{CE(sat)}$	Collector to emitter saturation voltage	$T_j=25\text{ }^\circ\text{C}$   $I_C=400A$	—	2.1	3.0	V
		$T_j=125\text{ }^\circ\text{C}$   $V_{GE}=15V$	—	2.4	—	
$C_{ies}$	Input capacitance	$V_{CE}=10V$	—	—	70	nF
$C_{oes}$	Output capacitance	$V_{GE}=0V$	—	—	6	
$C_{res}$	Reverse transfer capacitance		—	—	1.4	
$Q_G$	Total gate charge	$V_{CC}=600V, I_C=400A, V_{GE}=15V$	—	2000	—	nC
$t_d(on)$	Turn-on delay time	$V_{CC}=600V, I_C=400A$	—	—	550	ns
$t_r$	Turn-on rise time	$V_{GE1}=V_{GE2}=15V$	—	—	180	
$t_d(off)$	Turn-off delay time	$R_G=0.78\Omega, \text{Inductive load}$	—	—	600	
$t_f$	Turn-off fall time	switching operation	—	—	350	
$t_{rr}$ ①	Reverse recovery time	$I_E=400A$	—	—	250	
$Q_{rr}$ ①	Reverse recovery charge		—	16	—	$\mu C$
$V_{EC}$ ①	Emitter-collector voltage	$I_E=400A, V_{GE}=0V$	—	—	3.8	V
$R_{th(j-c)Q}$	Thermal resistance	IGBT part (1/2 module) *1	—	—	0.046	$^\circ\text{C/W}$
$R_{th(j-c)R}$		FWDi part(1/2 module) *1	—	—	0.085	
$R_{th(c-f)}$	Contact thermal resistance	Case to fin, Thermal compound Applied (1/2module) *2	—	0.02	—	
$R_G$	External gate resistance		0.78	—	10	$\Omega$

\*1:  $T_c, T_f$  measured point is just under the chips.

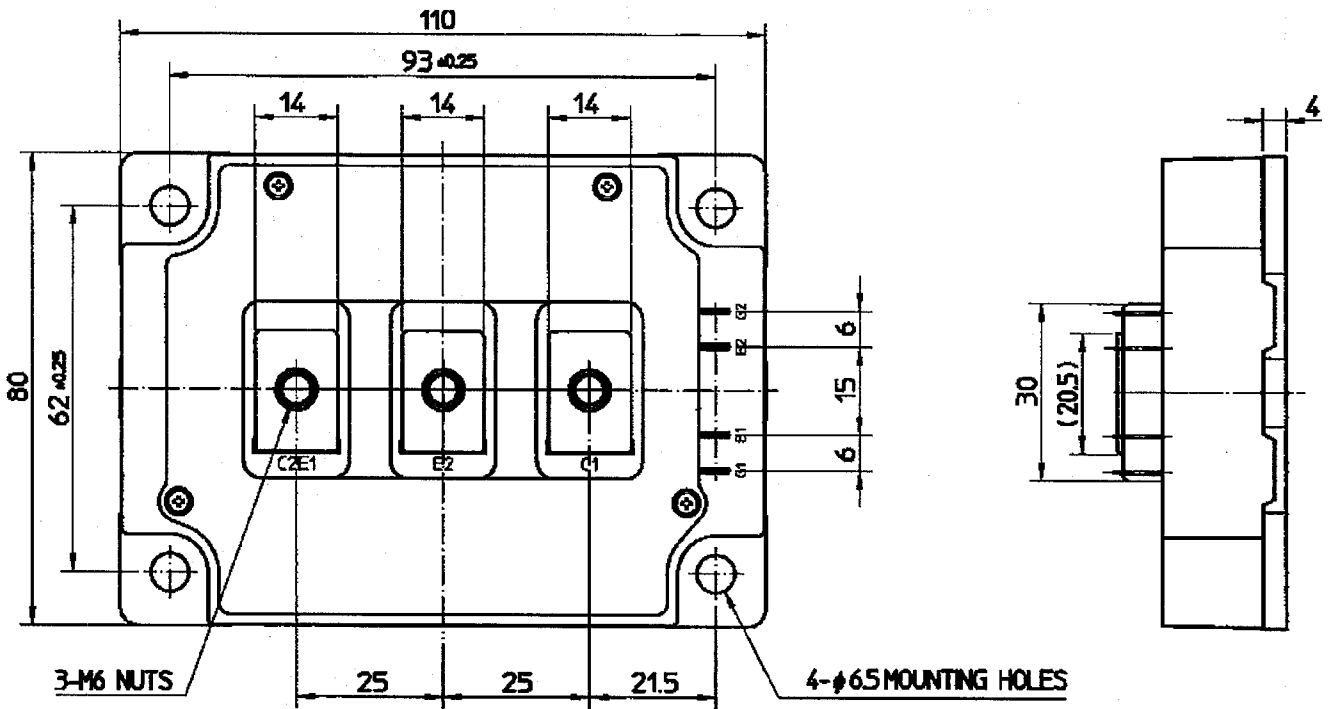
\*2: Typical value is measured by using Shin-etsu Silicone "G-746".

- ①  $I_E, V_{EC}, t_{rr}$  &  $Q_{rr}$  represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWDi).
- ② Pulse width and repetition rate should be such that the device junction temp. ( $T_j$ ) dose not exceed  $T_{jmax}$  rating.
- ③ Junction temperature ( $T_j$ ) should not increase beyond  $150^\circ\text{C}$ .
- ④ Pulse width and repetition rate should be such as to cause neglible temperature rise.

OUTLINE DRAWING

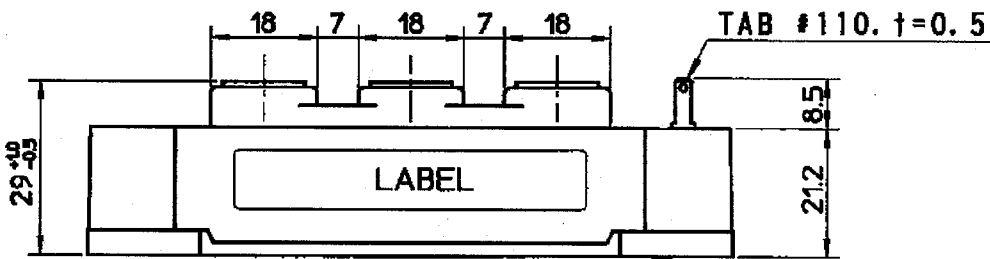
Dimensions in mm

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3-M6 NUTS

4-φ6.5 MOUNTING HOLES



TAB #110. t=0.5

CIRCUIT DIAGRAM

